KURUKSHETRA UNIVERSITY KURUKSHETRA

Revised Scheme of Examination and Syllabus for Under-Graduate Programme Subject: ELECTRONICS B23-ELE-501 & B23-ELE-503 B23-ELE-601 & B23-ELE-603

Under Multiple Entry-Exit, Internship and CBCS-LOCF in accordance to NEP-2020 w.e.f. 2024-25 (in phased manner)

		Demor(a)	Nomenclature of	Creadite	Hours/	Internal	External	Total	Exam
Remarks	Course	Paper(s)	Paper	Credits	Hours/ Week	marks	External Marks	Marks	Exam Duration
Scheme A, B & C	B23-ELE- 501	Microprocessor Architecture and Programming with 8085	3	3	20	50	70	3 hrs.	
, , , , , , , , , , , , , , , , , , ,	4 credit	201	Practical	1	2	10	20	30	3 hrs.
Scheme	MCC-10	B23-ELE-	Digital Signal Processing	3	3	20	50	70	3 hrs.
B & C	4 credit	502	Practical	1	2	10	20	30	3 hrs.
	DSE-2	B23-ELE-	Transducers and Sensors	3	3	20	50 20	70 30	3 hrs. 3 hrs.
Scheme	4 credit	503	Practical	1		10			
B & C	Select one Option	B23-ELE- 504	Optoelectronic Devices	3	3	20	50	70	3 hrs.
	Option		Practical Mechatronics	1 3	23	10 20	20 50	30	3 hrs. 3 hrs.
	DSE-3	B23-ELE- 505	Practical	<u> </u>	2	10	20	70 30	$\frac{3 \text{ hrs.}}{3 \text{ hrs.}}$
Scheme B & C	4 credit Select one	B23-ELE-	Introduction to Embedded Systems	3	3	20	50	70	3 hrs.
	Option	506	Practical	1	2	10	20	30	3 hrs.
Scheme A & C	CC-M5 (V) 4 credits		From Avail	able CC-M	5(V) of 4 cre	edits as per N	IEP		
Scheme A, B & C	Internship 4 credits		Inte	rnship#4 cre	edit after 4 th	semester			
			THIRD YEAR:	SEMESTI	E R-6				
Remarks	Course	Paper(s)	Nomenclature of Paper	Credits	Hours/ Week	Internal marks	External Marks	Total Marks	Exam Duration
Scheme A, B & C	CC-6 MCC-11	B23-ELE- 601	Interfacing Peripheral Devices and Applications of 8085	3	3	20	50	70	3 hrs.
,	4 credit		Practical	1	2	10	20	30	3 hrs.
Scheme B & C	MCC-12 4 credit	B23-ELE- 602	Basic Electrical Engineering & Skills	3	3	20	50	70	3 hrs.
		002	Practical	1	2	10	20	30	3 hrs.
	DSE-4	B23-ELE- 603	Microcontroller 8051 and its Interfacing	3	3	20	50	70	3 hrs.
Scheme B & C	4 credit	005	Practical	1	2	10	20	30	3 hrs.
Dac	Select one Option	B23-ELE- 604	Verilog and FPGA based System Design	3	3	20	50	70	3 hrs.
		004	Practical	1	2	10	20	30	3 hrs.
G 1	DSE-5	B23-ELE- 605	Introduction to C and its programming	3	3	20	50	70	3 hrs.
Scheme B & C	4 credit	003	Practical	1	2	10	20	30	3 hrs.
bαC	Select one Option	B23-ELE- 606	Modern communication systems	3	3	20	50	70	3 hrs.
		000	Practical	1	2	10	20	30	3 hrs.
Scheme A only	CC-M6 4 credits		From Ava	ailable CC-N	A6 of 4 cred	its as per NE	P		
Scheme A only	CC-M7(V) 4 credits		From Avail	able CC-M	7(V) of 4 cre	edits as per N	IEP		
Scheme B only	CC-M5(V) 4 credits		From Availa	able CC-M	5(V) of 4 cr	edits as per	NEP		
Scheme C only	CC-M6(V) 4 credits		From Availa	able CC-M	6(V) of 4 cr	edits as per	NEP		
COMV									

		Ses	ssion: 2024-25		
		Part A	A- Introduction		
Subject			ELECTRONI	CS	
Semester			FIFTH		
Name of th	e Course		Microprocesso 8085	or Architecture and H	Programming with
Course Co	de		B23-ELE-501		
	e:(CC/MCC/MD0 /OC/DSE/PC/AE		CC-5, MCC-9		
Level of the	e course		300-399		
Pre-requisit	te for the course(if any)	Basic knowle organization.	dge of digital electron	ics and computer
Course Learn (CLO):	ning Outcomes	 Perfo progra To u progra To au assem Presen Hands 	rm in depth stu amming using th inderstand varie amming. nalyze given pro- bly language. nt the experime	the learner will be able dy of microprocessor le Intel 8085 microproc ous instructions used oblem and write progra ntal results and concl in the Laboratory rough practicals	architecture and eessor. for low level rams using 8085
Credits		Theo	ory	Practical	Total
		3		1	4
Contact He	ours per week		3	2	5
	ks: 100 (70 Assessment Mark Exam Marks: 507	-	+10 Practical	Exam Time: 3 Theory & Practical	
		Part B-Con	tents of the Co	urse	
2. Ques comp each	pulsory. The rema	set in all. All c will be shor uning eight que e candidate wi	t answer type estions will be se ll be required to		vo questions from
Unit			Topics		Contact Hours
Ι	single chip micro	computer, Con & timing, CPU	nponents of Micr J, I/O devices, cl	microcomputer and roprocessor: Registers, lock, memory, bussed and control bus.	11
	Architecture an Microprocessor, Fetching and Exe	d Programmin Pin Description cuting Instruction	ng of 8085: A n of 8085, Instr ions, Idea of fetc	rchitecture of 8085 ruction set of 8085, th execute overlap	11
		ons, Arithmet	ic Operations,	nming Basics, Data Logic Operations, Programs	11

IV	Programming Technique : Looping, Counting, and Indexing, Additional Data Transfer and 16-Bit Arithmetic Instructions, Arithmetic Operations Related to Memory, Logic Operations: Rotate, Logic Operations: Compare	12
	8085 Programming : Programs of Addition, Subtraction, Multiplication, Division, Ascending/Descending, Largest/Smallest	
V*	Note: A candidate is required to perform minimum 5experiments,	30
	out of the list provided during course of study in this semester.	
	1. Addition and Subtraction of Two 8-Bit Numbers or microprocessor-Kit.	
	2. Addition and Subtraction of Two 16-Bit Numbers or microprocessor-Kit.	
	3. Multibyte Addition/Subtraction of two numbers by Repetitive	
	addition/subtraction on Microprocessor-kit.	
	4. Division of two 8-Bit numbers by repetitive subtraction	
	on microprocessor-Kit. 5. Multiplication of Two 8-Bit Numbers on Microprocessor –Kit.	
	6. Find the smallest/largest number from a give series of numbers	
	on Microprocessor-Kit.	
	7.To sort a given series of unsigned numbers in Ascending order	
	on Microprocessor-kit. 8.To sort a given series of unsigned numbers in Descending order	
	on Microprocessor-kit.	
	9. Check even parity/add parity of binary number on microprocessor-	
	Kit.	
T 4	Suggested Evaluation Methods	
Interna	al Assessment: Theory :20 Marks	End Term Examination:
•	Class Participation: 5 Marks	50 Marks
•	Seminar/presentation/assignment/quiz/class test etc.:5 Marks	
•	Mid-Term Exam: 10 Marks	
\checkmark	Practicum:10 Marks	20 Marks
•	Class Participation:	
•	Seminar/Demonstration/Viva-voce/Lab records etc.:10 Marks	
•	Mid-Term Exam:	
	Part C-Learning Resources	
Recom	mended Books/e-resources/LMS:	
1. Di	gital Computer Electronics- A P Malvino (2nd Edition)	

4. Introduction to microprocessor 8085, D K Kaushik, Dhanpat Rai Publications

		Ses	sion: 2024-25		
		Part	A-Introduction	I	
Subject			ELECTRONI	CS	
Semeste	r		FIFTH		
Name o	f the Course		TRANSDUC	ERS AND SENSORS	
Course	Code		B23-ELE-503	3	
	pe:(CC/MCC/MDC/ VOC/DSE/PC/AEC		DSE-2		
Level of	the course		300-399		
Pre-requ	isite for the course (if any)	Advance Kno	wledge of Electronics	
Course La (CLO):	earning Outcomes	 Understa the measure Applicati Apply sig Present Hands-or 	nd the principle urement and inst various mea ons. gnal conditioning	surements technique g for measurements of tal results and concl he Laboratory	nd transducers for es for industrial various quantities
Credits		The	ory	Practical	Total
		3		1	4
Contact	t Hours per week		3	2	5
+10 Pra	al) Internal Assessm	Theory+ 20 Pra	actical	& Practical	irs each for Theory
		Part B-Con	itents of the Co	urse	
2. Q co ea	ompulsory. The remain	e set in all. All c ch will be sho aining eight qu ne candidate w	ort answer type estions will be s ill be required t		two questions from
Unit			Topics		Contact Hours
Ι	Electrical, their c working of follo (Potentiometric,	comparison. Sel wing types: D Strain Gauges onductor strain	ection of Trans isplacement tra 5 – Types, Ga 1 gauge) Capa	assive, Mechanical, ducers, Principle and nsducers - Resistive auge Factor, bridge active (diaphragm),	11
II	Characteristics (linearity, threshol Speed of responserrors, statistical	: Transducers Accuracy, repe d, sensitivity, re se, settling time analysis, pro	and sensors- a atability, reprod esolution, hyster e, fidelity, lag e bability of erro	easurement and Static and Dynamic ucibility, range/span, resis, precision, drift, etc. Errors (Types of ors, limiting errors) n of sensors, Sensor	12

	calibration techniques	
III	Sensors: Piezoelectric (Element and their properties, Piezo Electric coefficients. Equivalent circuit and frequency response of P.E. Transducers), light (photo-conductive, photo emissive, photo voltaic, semiconductor, LDR),Temperature (electrical and non-electrical). Pressure (force summing devices, load cell)	10
IV	Magnetic Sensor, Optical Sensors and Special Sensors: Magnetic Sensors –types, principle, requirement and advantages: Magneto resistive – Hall Effect – Current sensor, Optical Sensors - Photo conductive cell, photo voltaic, Photo resistive, IR sensor, LDR, Fibre optic sensors, Special Sensors: GPS, Bluetooth, Smart Sensors - Film sensor. Touch screen sensor	12
V*	 Note: A candidate is required to perform minimum 5 experiments out of the list provided during course of study in this semester. 1. To determine the Characteristics of resistance transducer - Strain Gauge (Measurement of Strain using half and full bridge.) 2. To determine the Characteristics of LVDT. 3. Measurement of distance using LVDT plot ac and dc characteristics. 4. To determine the Characteristics of Thermistors and RTD. 5. Measurement of temperature by Thermocouples. 6. Study of transducers like AD590 (two terminal temperature Sensor), PT-100, J- type, K- type. 7. To study the Characteristics of Phototransistor: (i) Variable Illumination. (ii) Linear Displacement. 9. Characteristics of one Solid State sensor/ Fibre optic sensor 	30
Intorno	Suggested Evaluation Methods	End Term
	Theory 20 Marks	Examination:
-	Class Participation: 5 Marks	50 Marks
•	Seminar/presentation/assignment/quiz/class test etc.: 5 Marks Mid-Term Exam: 10 Marks	
> • •	Practicum 10 Marks Class Participation: Seminar/Demonstration/Viva-voce/Lab records etc.:10 Marks Mid-Term Exam:	20 Marks
	Part C-Learning Resources	
	mended Books/e-resources/LMS:	
	Kalsi, Electronic Instrumentaion, TMH(2006)	1 .
	Cooper and A. D. Helfrick, Electronic Instrumentation and Measurement Te	chniques,
	Hall (2005).	
	nentation Measurement and analysis: Nakra B C, Chaudry K, TMH Sawhney, Electrical and Electronics Measurements and Instrumentation,	
	Rai and Sons (2007).	
5. C. S. F	Rangan, G. R. Sarma and V. S. Mani, Instrumentation Devices and Systems, Hill (1998).	Tata
6 Patran	abis D, "Sensors and Transducers", 2nd Edition, PHI, New Delhi, 201	

		Ses	ssion: 2024-25		
		Part	A- Introduction		
Subje	ct		ELECTRONI	CS	
Semes	ster		SIXTH		
Name	e of the Course		INTERFACIN APPLICATIO	G PERIPHERAL DEV NS OF 8085	ICES AND
Cours	se Code		B23-ELE-601		
	e Type: (CC/MCC/M EC/VOC/DSE/PC/AEC		CC-6 MCC-	11	
Level	of the course		300-399		
Pre-re	quisite for the course(if	any)	Basic idea of 8	3085 architecture and it	s programming
Course (CLO):	Learning Outcomes	1. L 2. und 3. Lea 4. Stud of 80	earn various inte lerstand about 82 rn about the Tim dy about the DM 185.		ocessor. mming applications
Credi	its	Theory		Practical	Total
		3		1	4
Cont	act Hours per week		3	2	5
Pract Pract			Theory +10	Exam Time: 3 Ho & Practical	urs each for Theory
End	Term Exam Marks:50 T	•	tents of the Cou	rse	
candida each ui	maining eight questions ate will be required to a	e set in all. All o h will be short a s will be set un attempt question	inswer type cove it wise selecting No. 1 and four	ry equal marks. ring the entire syllabus two questions from ea	ch Unit I to IV. The ng one question from
Unit		г	Fopics		Contact Hours
Ι	Interrupts: Methods of Input/output operations, Data transfer Schemes, software Interrupts, Hardware interrupts, Interrupt control circuits, Interrupt instructions.			11	
II	Programmable Pe 8255, control wor programming in M	e ripheral Interf d format for 8	255, programmi	ng in Mode 0,	11
III	Programmable Ir control word forma Programming of 82	nterval Timer at for 8253, Inter	8253: Block dia rfacing & progra	agram of 8253,	10
IV	Programming of Microprocessor in: 1. Traffic lig	8257, Applic		ns: Block diagram, strate the use of	13

	 Stepper Motor control Washing machine control. 	
V*	 Note: A candidate is required to perform minimum 5 experiments out of the list provided during course of study in this semester. 1. Program to generate Square wave using Microprocessor-Kit. 2. Program to generate Sine wave using Microprocessor-Kit. 3. Program to generate triangular wave using Microprocessor-Kit. 4. Generate a time delay through software on Microprocessor-Kit and switch ON/OFF LED using IC 8255. 5. Write program to operate Stepper Motor using Microprocessor-Kit. 6. Write program to illustrate the use of Microprocessor in Traffic light system. 7. ADC interfacing using Microprocessor-Kit. 8. DAC interface using Microprocessor-Kit. 9. Interfacing of stepper motor and Rotating stepper motor by N 	30
	Steps clockwise/ anticlockwise with speed control.	
	Suggested Evaluation Methods	
Inter	nal Assessment:	End Term
\blacktriangle	Theory: 20Marks	Examination:
•	Class Participation: 5 Marks Seminar/presentation/assignment/quiz/class test etc.: 5 Marks Mid-Term Exam: 10Marks	50 Marks
\blacktriangle	Practicum10Marks	20 Marks
•	Class Participation: Seminar/Demonstration/Viva-voce/Lab records etc.: 10 Marks Mid-Term Exam:	
	Part C-Learning Resources	
 Digital Microp Fundar 	mmended Books/e-resources/LMS: Computer Electronics- A P Malvino (2nd Edition) processor Architecture, programming and application with the 8085 by R S Gaonk mentals of Microprocessors and Microcontrollers by B.RAM action to microprocessor 8085, D K Kaushik, Dhanpat Rai Publications	ar

	S	ession: 2024-25		
	Par	t A- Introduction	1	
Subject		ELECTRONIC	CS	
Semester		SIXTH		
Name of the Course		MICROCONTE	ROLLER 8051 AND IT	INTERFACING
Course Code		B23-ELE-603		
Course Type: (CC/MC) DSEC/VOC/DSE/PC/AE		DSE-4		
Level of the course		300-399		
Pre-requisite for the cours	e (if any)	-		
Course Learning Outcome (CLO):	1. Und 2. Und mic 3. Und be a 4. Inte mic	lerstand the basic lerstand the diff rocontroller. lerstand the instru- ble to write simpl	/O devices with n	a microcontroller. nicroprocessor and cocontroller and will
Credits	Th	eory	Practical	Total
		3	1	4
Contact Hours per week		3	2	5
Max. Marks: 100 Practical) Internal Assessment M End Term Exam Marks:	•	+10 Practical	Exam Time: 3 Hou & Practical	irs each for Theory
		ontents of the Co	ourse	
compulsory. The re each Unit I to IV. questions selecting	be set in all. All nich will be sh maining eight qu The candidate w	ort answer type testions will be se vill be required to n each unit.		wo questions from . 1 and four more
Unit Architecture	of 8051 Micr	Topics	sic block diagram of	Contact Hours
microcontrolle Architecture - diagram, mem General purp external memo	r, Comparison o internal block de ory organization ose data memory ory.	f microcontroller iagram and key , Internal RAM m ry, special purpo	with microprocessors, features of 8051, pin emory, Internal ROM. ose/function registers,	11
program coun modes of ope serial data in modes. Pro	tter, TCON, TM ration. Input / ou	MOD, timer cou utput ports and ci CON, PCON, se i1 timers, co	oscillator and clock, nter interrupts, timer ircuits/ configurations, rial data transmission unter programming,	12

III	Interrupts, Addressing modes, Instruction set and Interfacing: Interrupts, reset, interrupt control, interrupt priority, and interrupt destinations & software generated interrupts. Addressing modes, Data transfer instructions, Arithmetic and Logic operations, , flags, internal data move, external data move, code memory read-only data move, Push and Pop and data exchange instructions	11
IV	 Interface and Applications: Develop the following applications with 8051 microcontroller using assembly language: i) Stepper-motor interface, ii) ADC interface, iii) DAC interface, iv) Keyboard interface 	11
V*	 Note: A candidate is required to perform minimum 5 experiments out of the list provided during course of study in this semester. 1. Program to find the sum of N 8-bit numbers. 2. Program to find largest of N numbers. 3. Program to find smallest of N numbers 4. Program to find whether the given data is palindrome. 5. Program to arrange the numbers in ascending order. 6. Interfacing of stepper motor and Rotating stepper motor by N Steps clockwise/ anticlockwise with speed control. 7. ADC interfacing. 8. DAC interface 9. Keyboard interface 	30
	Suggested Evaluation Methods	
Intern	al Assessment:	End Term
<i>ک</i>	Theory 20 Marks Class Participation: 5 Marks	Examination : 50 Marks
• • > Pi	Seminar/presentation/assignment/quiz/class test etc.: 5 Marks Mid-Term Exam: 10Marks racticum10Marks	20 Marks
•	Class Participation: Seminar/Demonstration/Viva-voce/Lab records etc.: 10 Marks Mid-Term Exam:	
	Part C-Learning Resources	
1.] 2.]	mended Books/e-resources/LMS: Muhammad Ali Mazidi, "Microprocessors and Microcontrollers", Pearson, 2 Muhammad Ali Mazidi, Janice Gillispie Mazidi, Rolin D. MCKinlay "The 8 Microcontroller and Embedded Systems", 2nd Edition, Pearson Education 2	051

- 3. "Programming and Customizing the 8051 Microcontroller" by Myke Predko
- 4. The 8051 Microcontroller Based Embedded Systems", Manish K Patel, McGraw Hill, 2014, ISBN: 978-93-329-0125-4.
- 5. "Microcontrollers: Architecture, Programming, Interfacing and System Design", Raj Kamal, Pearson Education, 2005.

	Se	ssion: 2023-24		
	Part	A - Introductio	n	
Subject		ELECTRONICS		
Semester		III/V		
Name of the Course		MOBILE PHON	E REPAIRING	
Course Code		B23-VOC-118		
Course Type: (CC/MCC/M M/DSEC/VOC/DSE/PC/AI		VOC		
Level of the course		100-199		
Pre-requisite for the course (if any) Physics as a Subject at 4.0 Level (Class XII)		(11)		
Course Learning Outcomes (CLO):	1. To ren camera 2. Mobile 3. How to 4. Unlock	nove and fix a a, speaker, jumpe e phone Assembl o change/repair r	e, the learner will be ab all mobile components er, SIM, Headphone jack ing & Dissembling nobile screen (folder) P, Pattern, Password, PII tware updates	like charger jacl etc.
Credits	Th	eory	Practical	Total
		2	2	4
Contact Hours		2	4	6
Max. Marks: 100 (50 T Internal Assessment Marks: 1 End Term Exam Marks: 35 T	•	Practical	Exam Time: 3 Hours Practical	each for Theory &
	•	ontents of the (Course	
compulsory. The rema	set in all. All q ch will be sh ining eight qu le candidate w	ort answer typ estions will be vill be required		wo questions from

Unit	Topics	Contact Hours
Ι	Basics of Electronics : Understanding Electrical Components: Resistors, Capacitors, Inductors, Diodes, Transistors and Transformer, Ohm's Law and basic circuit theory, Use of Multi-meter, DC Power Supply and Oscilloscope, Soldering and De-soldering techniques	7
Π	Mobile Phone Hardware : Introduction to Mobile Phone Components, Circuit Diagrams and Block Diagrams of Phones Battery, Display, Charging Section, Speaker & Microphone repair, Troubleshooting Hardware Issues, Mobile Phone Disassembly and Reassembly, Diagnosis of Common Problems: Dead phones, No charging, No sound, Display issues	7
III	Software in Mobile Phones : Flashing and Formatting mobile phones, Understanding IMEI and Software Locks, Operating Systems (Android/iOS): Introduction, Basics of Firmware, Flashing Tools (e.g., SP Flash Tool, Odin), Unlocking Methods: FRP Lock, Password, and Pattern Unlocking, Software Troubleshooting: Software crashes, Boot loop, Stuck at logo	7
IV	Troubleshooting, Diagnosis and Advanced Hardware Repair : Systematic Problem Solving: Using Circuit Diagrams and Schematics, Identifying short circuits, testing different parts, and fixing issues, Common faults and their fixes for different phone brands (Samsung, Apple, Xiaomi, etc.) Chip-level repairs: IC replacement, jumper settings, board soldering, Network, Bluetooth and Wi-Fi repair, Understanding GSM and CDMA Technologies, Water-damaged mobile repair, Troubleshooting advanced issues like SIM card not detected, Network issues	9
V*	 Note: A candidate is required to perform minimum 6 experimentsout of the list provided during course of study in this semester and need to prepare a report on an industrial visit. 1. Identification of basic Electrical & Electronic components : Resistors, Capacitors, Diode, Transistors, ICs 2. Measurement of current and voltage (AC/DC) using Ammeter and Voltmeter and Identification of legend, symbols, colour codes etc. 3. Measurement of current, voltage and resistance and testing of various using of Multimeter. 4. Measurement of amplitude, time period and frequency of signal using CRO. 5. Soldering & de-soldering of various electronic components/ICs on PCB. 6. To study various mobile hardware issues like : Dead phones, No charging(battery). 7. To study various mobile hardware issues like : Water damaged mobile repair. 	60

 8. To study various mobile hardware issues like : No sound(speaker) Display issues(screen). 9. To study various mobile software issues like: Formatting mobile ph Understanding IMEI and Software Locks. 10. To study various mobile software issues like: Unlocking Methods Lock, Password, and Pattern Unlocking. 11. To study various mobile software issues like: SIM card not detected Network issues, Bluetooth. 12. Visiting a mobile repair centre and preparing a PPT amd PDF repor various hardware and software issues. 	ones, s-FRP I,
Suggested Evaluation Methods nternal Assessment:	End Term
 Theory 15 Marks Class Participation: 4Marks Seminar/presentation/assignment/quiz/class test etc.: 4 Marks Mid-Term Exam: 7 Marks 	Examination: 35 Marks
 Practicum 15 Marks Class Participation:05 Seminar/Demonstration/Lab records etc.: 10 Marks 	35 Marks
Part C-Learning Resources	
 Recommended Books/e-resources/LMS: Basic Electronics for Mobile Repairing" by Manohar Lotia Mobile Phone Repairing Made Easy" by A.K. Jha Mobile Software Repairing Manual" by Shyamal Mitra Advanced Mobile Repairing" by B.G. Gupta Mobile Repair Guide: Troubleshooting Techniques" by Santosh Atra 	